PW PACKAGE (TOP VIEW)

IN-2 Γ

E/O2 **1** 2

V_{CC} **[**] 3

OUT2 | 4

OUT3 [5

OUT1 **1** 6

GND **∏** 7

SCP 1 8

16 TE/O3

15 ∏ IN-3

14 | IN-1

13 TE/O1

12 CT/RT

11 **□** DTC2

10 DTC1/3

9 VREF

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- Low Voltage Operation . . . 2.5 V to 7 V
- Low Power . . . 3. 5 mA (f = 500 kHz, Duty = 50%)
- Internal Undervoltage Lockout Protection
- Internal Short Circuit Protection
- Wide Operating Frequency . . . 50 kHz to 1 MHz
- Internal Precision Reference . . . 1.25 V ±1% (25°C)
- On/Off Switch for CH1/3 Pair and Ch2 (see Function Table)
- 0 to 100% Dead Time Control
- Totem Pole Output Stage
- Smal I Package . . . 16 Pin TSSOP

description

The TPS5100 is a triple PWM control circuit, primarily designed to compose the power supply for LCD display. Each PWM channel has own error amplifier, PWM comparator, dead-time control and output driver. The trimmed voltage reference, oscillator, undervoltage lockout and short circuit protection are common for all channels.

This device includes two boost exclusive circuits (ch1,3) and a buck-boost exclusive circuit (ch2). The operating frequency is set with external resister and capacitor, and dead time is continuously adjustable form 0% to 100% duty cycle with resistive divider network. Soft start function can be implemented by adding a capacitor to dead time divider network. Two dead time control inputs are assigned for ch1,3 pair and ch2 individually and each dead time control input can be used to control on/off operation. TPS5100 can operate from 2.5 V supply voltage and ch1,3 pair and ch2 operate with reverse phase switching each other to achieve efficient operation in low power and battery powered system.

The TPS5100 is characterized for operation from -20°C to 85°C.

FUNCTION TABLE

CONDITION			
CONDITION	CH-1	CH-2	CH-3
DTC1/3 >. 0.3 V, DTC2 > 0.3 V	ON H	ON L	ON H
DTC1/3 > 0.3 V, DTC2 <. 0.2 V	ON H	OFF H	ON H
DTC1/3 < 0.2 V, DTC2 > 0.3 V	OFF L	ON L	OFF L
DTC1/3 < 0.2 V, DTC2 < 0.2 V	OFF L	OFF H	OFF L

AVAILABLE OPTIONS

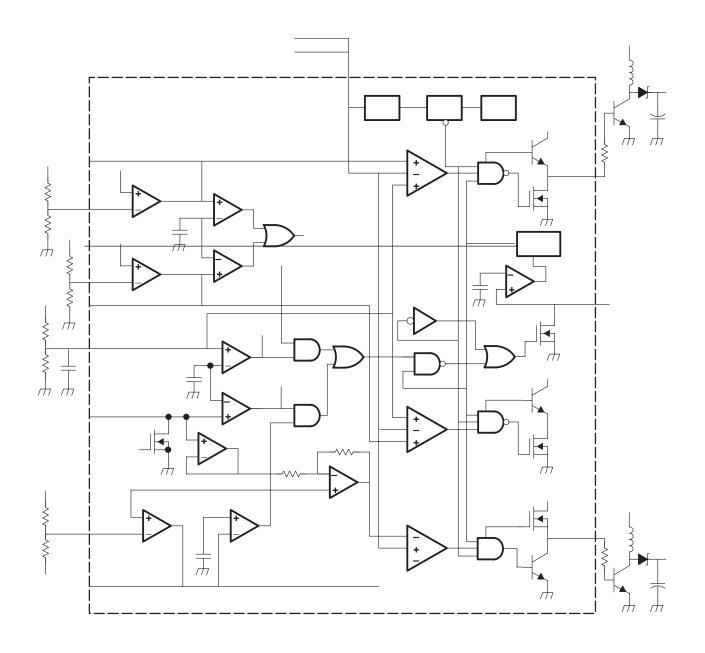
	PACKAGE
TA	TSSOP
	(PW)
-20°C to 85°C	TPS5100PW



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functional block diagram





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electrical characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3 \text{ V}$ (unless otherwise noted) (see Note 1)

	PARAMETER		TEST CONDITIONS			MAX	UNIT
VREF	Reference voltage	$I_{REF} = -1 \text{ mA},$	T _A = 25°C	1.237	1.250	1.263	V
VREF(dev)	Reference voltage change with TA	$I_{REF} = -1 \text{ mA},$	See Note 2		15	25	mV
REGIN	Input regulation	$I_{REF} = -1 \text{ mA},$	$V_{CC} = 2.5 \text{ V to 7 V}$		2	5	mV
REGL	Output regulation	I _{REF} = -0.1 mA to -1 mA			1	5	mV
los	Short-circuit output current	$V_{REF} = 0$		-2	-10	-30	mA

NOTES: 1. Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25$ °C.

2. The deviation parameter V_{REF(dev)} is defined as the difference between the maximum and minimum values obtained over the recommended free-air temperature range (–20°C to 85°C).

undervoltage lockout section

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VTH	Upper threshold voltage	T _A = 25°C	2.2	2.3	2.4	V
VTL	Lower threshold voltage	T _A = 25°C	2	2.1	2.2	V
V _{hys}	Hysteresis (V _{TH} – V _{TL})	T _A = 25°C	0.1	0.2	0.3	V

NOTE 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25^{\circ}C$.

protection control section

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ISCP	Input terminal source current		-1.4	-2	-2.6	μΑ
V _{T2}	Input threshold voltage	CH-1, 3	1.10	1.15	1.20	V
V _{T3}	Input tilleshold voltage	CH-2	0.20	0.25	0.30	V
٧R	Latch reset threshold voltage	T _A = 25°C	0.8	1.5		V
V _{T5}	Threshold voltage		1.20	1.25	1.30	V

NOTE 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25$ °C.

oscillator section

	PARAMETER		TEST CONDITIONS			MAX	UNIT
fosc	Frequency	$C_T = 130 pF$,	$R_T = 7 \text{ k}\Omega$	400	500	600	kHz
fdV	Frequency change with V _{CC}	$V_{CC} = 2.5 \text{ V},$ $C_{T} = 130 \text{ pF},$	$T_A = 25^{\circ}C$, $R_T = 7 \text{ k}\Omega$		1%	2%	
fdT	Frequency change with TA	$C_T = 130 pF$,	$R_T = 7 \text{ k}\Omega$		5%	10%	
I _{CT/RT}	Output source current			-180	-200	-220	μΑ
Vosch	H level output voltage			0.95	1	1.05	V
Voscl	L level output voltage			0.35	0.40	0.45	V

NOTE 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25^{\circ}C$.

dead time control section

dodd tillio dollar o' doddoll								
	PARAMETER	TEST C	MIN	TYP	MAX	UNIT		
I _{BDT1/3}	Input bias current	$V_{DTC1/3} = 0.35$	V _{DTC1/3} = 0.35 V to 1.05 V			200	nA	
I _{BDT2}	input bias current	V _{DTC2} = 0.35 \	V to 1.05 V		±2	±20	IIA	
V _{T1}	Comparator threshold voltage		0.2	0.25	0.3	V		
V _{T0} (DTC1/3)	Input threshold voltage (DTC1/3) (see Note 3)	Duty = 0%	fo.o.o. — 500 kHz	0.3	0.4	0.5	V	
VT100(DTC1/3)	input tilleshold voltage (DTC1/3) (see Note 3)	Duty = 100%	fOSC = 500 kHz	0.9	1	1.1	V	
V _{T0} (DTC2)	Input threshold voltage (DTC2) (see NOte 3)	Duty = 0%	fo.co - 500 kHz	0.3	0.4	0.5	V	
VT100(DTC2)	imput tirreshold voltage (DTC2) (see NOte 3)	Duty = 100%	fOSC = 500 kHz	0.9	1	1.1	V	

NOTES: 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25^{\circ}C$.

3. These specifications are not production tested. They are specified as ensured values on circuit design.



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electrical characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3 \text{ V}$ (unless otherwise noted) (see Note 1) (continued)

error amplifier section

	PARAMETER	TES	T CONDITIONS	MIN	TYP	MAX	UNIT
VIO	Input offset voltage	CH1, 3,	A _V = 1			15	mV
1	I _{IB} Input bias current		$V_I =95 \text{ V to } 1.55 \text{ V}$		±10	±20	nA
¹ IB	input bias current	CH2,	V _I = 0.4 V to 1 V		±10	±20	IIA
\/.=	Input voltage range	CH1, 3,		0.95		1.55	V
VIR	CH2		0.4		1	v	
A _{VD}	Open-loop voltage amplification	$R_{FB} = 200 \text{ k}\Omega$			60		dB
B ₁	Unity-gain bandwidth				1		MHz
V _{OM+}	Output voltage swing	V _{ID} = 0.1 V	ΙΟ = 60 μΑ	1.2			V
V _{OM} -	Output voltage swing	VID = 0.1 V	I _O = 0.2 mA			0.2	v
I _{OM+}	Output sink current	$V_{ID} = 0.1 V$,	V _O = 0.2 V	0.2	1		mA
I _{OM} _	Output source current	$V_{ID} = 0.1 V$,	V _O = 1.2 V	-60	-100		μΑ
\/_ (Input hise voltage	CH2,	$A_V = 1$, $T_A = 25^{\circ}C$	678	700	722	mV
V 14	V _{T4} Input bias voltage CH2		A _V = 1	665	700	735	IIIV

NOTE 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25^{\circ}C$.

output section

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VOH High-level output voltage		I _O = 20 mA (CH2)	2.9	3.05		V
VOH High-level output voltage	$I_O = -40 \text{ mA (CH1, 3)}$	1.9	2.2	2.6	٧	
\/	Low-level output voltage	I _O = 20 mA (CH1, 3)		0.2	0.4	V
VOL	Low-level output voltage	$I_O = 40 \text{ mA (CH2)}$	0.2	0.3	0.6	V
t _r	Rise time	CL = 1000 pF		130		ns
tf	Fall time	I _O = 1000 pF		50		ns

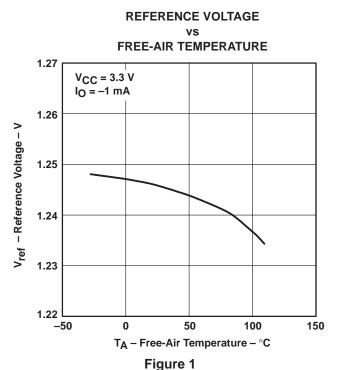
NOTE 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25^{\circ}C$.

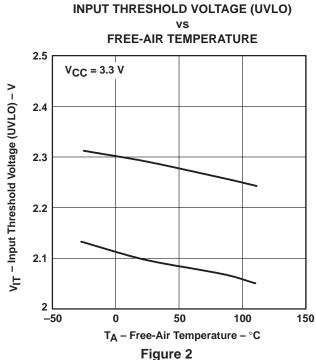
total device

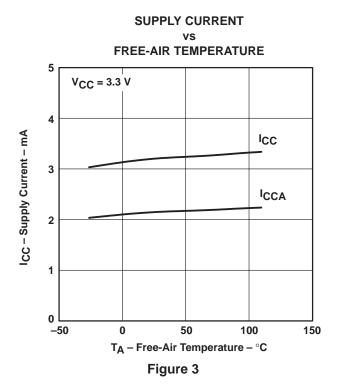
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ICC	Supply current	Output OFF state		2.5	4	mA
ICCA	Average supply current	FOSC = 500 kHz, Duty = 50%, No load		3.5	5	mA

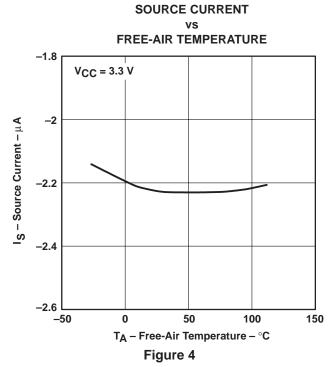
NOTE 1: Typical values of all parameters except for $V_{REF(dev)}$ and f_{dT} are specified at $T_A = 25$ °C.

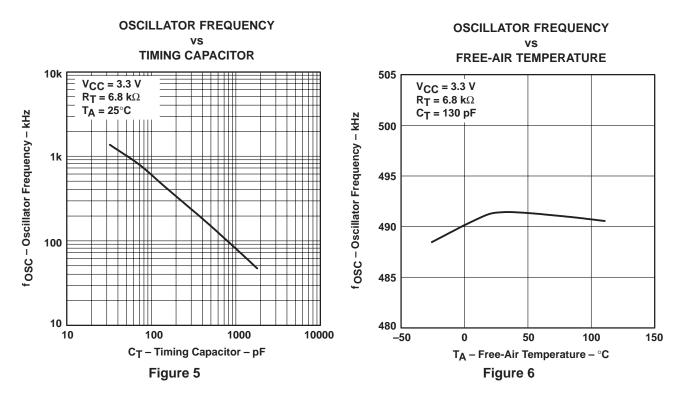












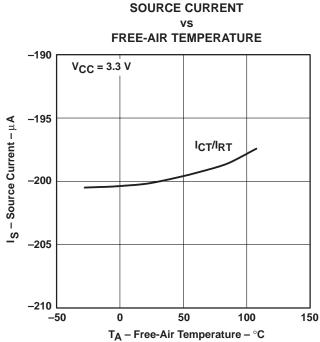
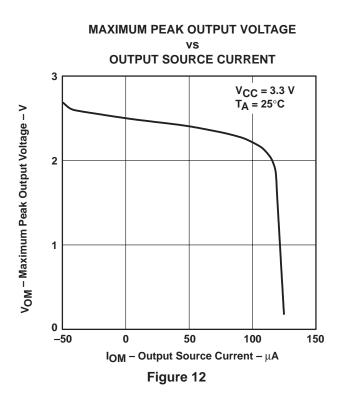
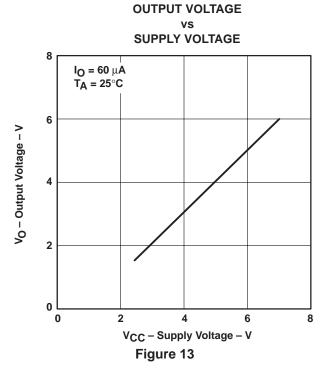
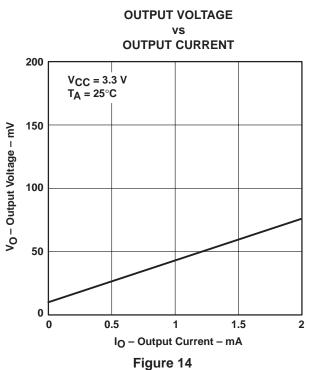


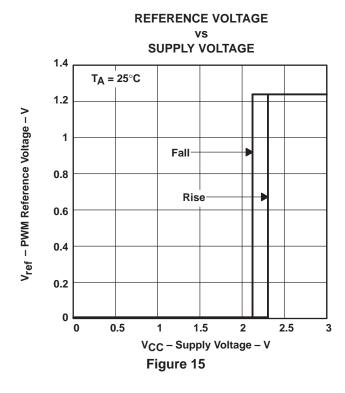


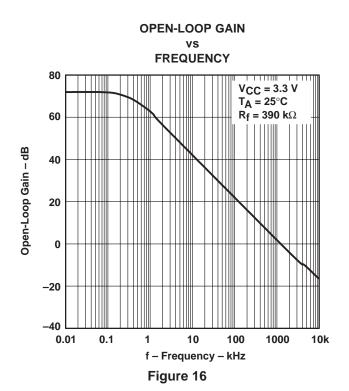
Figure 7

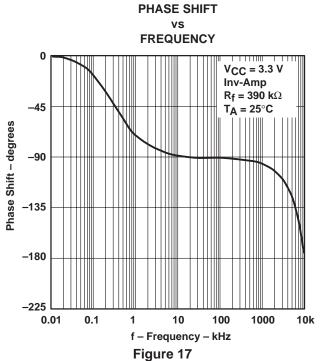












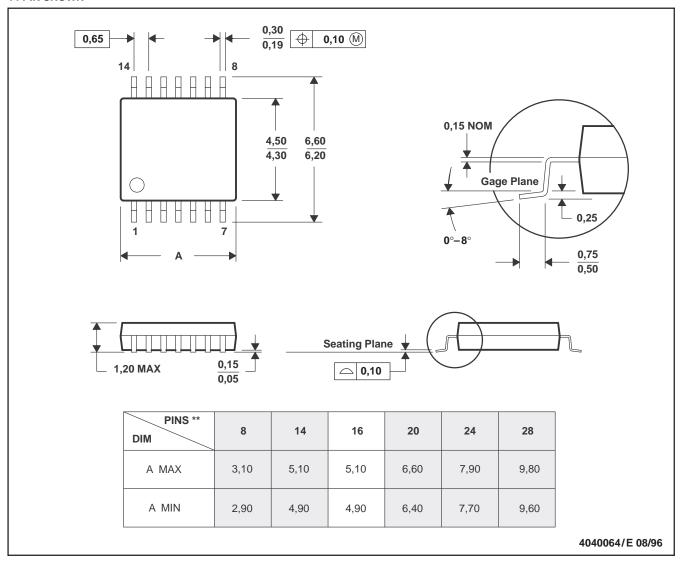
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MECHANICAL DATA

PW (R-PDSO-G**)

14 PIN SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





com 31-Mar-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TPS5100IPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS5100IPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TPS5100IPWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS5100IPWR	TSSOP	PW	16	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1
TPS5100IPWRG4	TSSOP	PW	16	2000	330.0	12.4	7.0	5.6	1.6	8.0	12.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS5100IPWR	TSSOP	PW	16	2000	346.0	346.0	29.0
TPS5100IPWRG4	TSSOP	PW	16	2000	346.0	346.0	29.0

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